# RTP System **REAL RTP series**





## **REAL RTP series**

Model	REAL RTP-100	REAL RTP-150	REAL RTP-200
Picture		Zon	e Control
Product Sample	Si, Sapphire, Glass, Ceramic, etc.	Si, Sapphire, Glass, Ceramic, etc.	Si, Sapphire, Glass, Ceramic, etc.
Substrate Size	4inch	6inch	8inch
Substrate holder	SiC coated graphite	SiC coated graphite	SiC coated graphite
Temperature Range	150~1,250°C	150~1,250°C	150~1,250°С
Heating Rate	10~200°C/sec	10~150°C/sec	10~150°C/sec
Control Zone	1-zone	3-zone	6-zone
Temperature Uniformity	±3°C	±3°C	±3°C
Temperature Accuracy	±2°C	±2°C	±2°C
Vacuum	Standard : 5.0E-3 Torr Option : 1.0E-6 Torr	Standard : 5.0E-3 Torr Option : 1.0E-6 Torr	Standard : 5.0E-3 Torr Option : 1.0E-6 Torr
Gas Supply	3 channels (Extensible)	3 channels (Extensible)	3 channels (Extensible)
Control	PC control	PC control	PC control

# Various RTP System

#### **Tube Type RTP**





Product sample	Si, Sapphire, Glass, Ceramic, etc.	
Substrate size	Piece	
Temperature range	150~1,200°C	
Control zone	1-zone	
Application	Graphene CVD Silicon nano wire growing Carbon nano tube CVD SIC epitaxy	

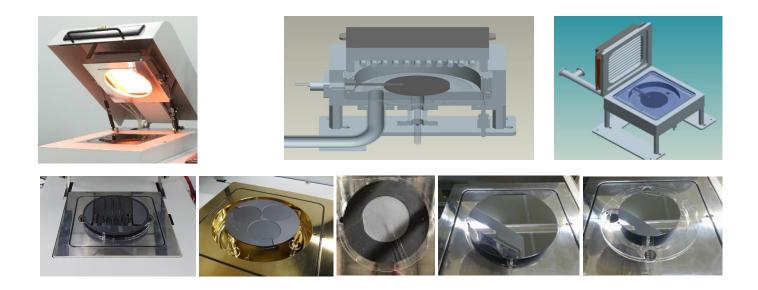
#### Mini Type RTP



Product sample	Optical fiber, Metal wire, Si, Sapphire, Glass, Ceramic, etc.	
Substrate size	Piece	
Temperature range	150~1,000°C	
Control zone	1-zone	
Vacuum	Standard - ATM	
	Option - 5.0E-3Torr	
Application	Evaluate Tensile strength by temperature in testing tensile strength of optical fiber	
Advantage	Low cost, Fast heating, Fast cool down, Desk top style, good for R&D purpose, Rapid heating and cooling available using halogen lamp	

## **REAL RTP**

### = REAL T/C Kit + RTP System









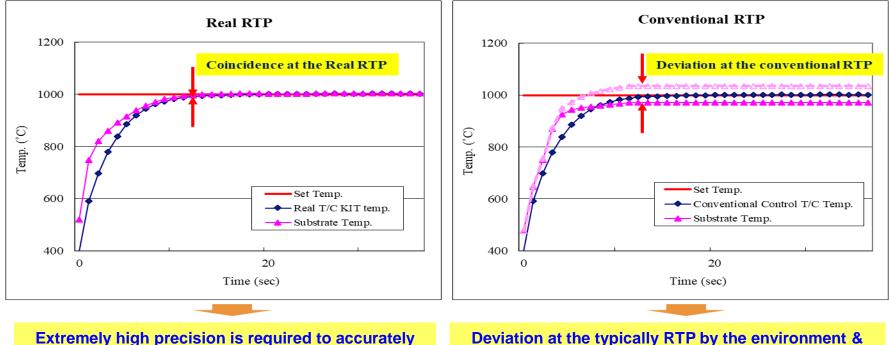


**REAL T/C KIT for Sapphire wafer** 

# **REAL RTP Advantage**

- Real substrate temperature
- Accurate temperature control
- Unnecessary compensation
- High reliability

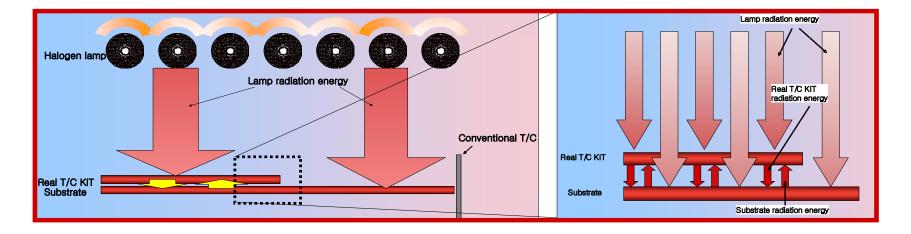
Low cost



extremely high precision is required to accurately and reliably temperature of the sample Deviation at the typically RTP by the environment & the situation  $\rightarrow$  compensation is needed

## **REAL RTP Advantage**

When the halogen lamp is heated by the temperature controller in a PID way to reach set temp, radiant energy of the lamp is released, which leads to heat substrate and the real TC KIT, radiant energy released from the heated substrate is additionally heated, by repeating all this process, finally temperature of substrate and the real TC KIT becomes equal.



# **REAL RTP Advantage**

Using a conventional T/C, the real temperature of Au-deposited wafers that you have to heat to 800 degrees is actually not 800 degrees.

**REAL T/C KIT** with the same material as the actual wafer(substrate) to be used for real-time accurate temperature control is possible.

